Abstract

This document describes the connectivity between the Dialog Semiconductor DA9061/2 Power Management Integrated Circuits (PMICs) and NXP i.MX 7Solo system application processors.
DA9061/2 and NXP i.MX 7Solo Power Connections

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1 Terms and Definitions

BOM  Bill of materials
GUI  Graphical user interface
PMIC  Power management integrated circuit
DVC  Dynamic voltage control
DVS  Dynamic voltage scaling. Analogous to DVC
POR  Power-on reset
RTC  Real-time clock
SNVS  Secure non-volatile storage

2 References

[3] In-Circuit Programming of DA9061/2/3, AN-PM-080, Dialog Semiconductor
[4] i.MX 7Solo Applications Processor Reference Manual, IMX7SRM, Rev. 0.1, 08/2016, NXP
[5] i.MX 7Solo Family of Applications Processors Datasheet, IMX7SCEC Rev. 5, 07/2017, NXP.
[8] Reference design files, DA9062_iMX7_design_files.zip, Dialog Semiconductor
[9] Design files, DA9062 WaRP7 CPU Board, DA9062_WaRP7_CPU_Board_design_files.zip, Dialog Semiconductor
3 Introduction

The NXP® i.MX 7Solo™ processor requires dedicated power management for a stable and reliable system. The Dialog DA9061 and DA9062 PMICs provide a convenient and flexible solution that meets the processor power requirements. Although system power consumptions vary due to the differing demands of peripherals, processor, and so on, the DA9061 has sufficient headroom to meet the power requirements of most i.MX 7S systems. The features of DA9061 enable significant power saving, such as dynamic voltage control (DVC) which intelligently manages voltage changes. The DA9061 significantly reduces system cost and size compared to an equivalent discrete solution.

This document provides details of integrating the DA9061 into an i.MX 7Solo system, based on the 'WaRP7 IoT and Wearable Development Platform' [1]. General guidance can be found in the other NXP references listed in Section 2. The focus here is on DA9061 as it creates the lowest cost solution. However, where a system requires further capabilities such as an SNVS coin-cell charger, additional power rails, real-time clock (RTC), or support for powering-down only VDD_ARM in Low-Power Mode, then the DA9062 provides these capabilities. Systems with higher power demands, such as the NXP SABRE Board [2] and i.MX 7Dual™ processor, are discussed in a separate application note.

4 i.MX 7S Power Requirements

All power domains of an i.MX 7 processor require precise power management to ensure reliable system operation. The main domains are:

- **VDD_SOC and VDD_ARM**: supplies the internal peripherals and the internal ARM™ cores
- **VDD_SNVS_IN**: supplies the SNVS regulator for the RTC and SNVS (secure non-volatile storage)

Additional supplies may be required for DDR memory, peripherals, I/O interfaces, USB, and so on. The power management system must also comply with the processor power-up and power-down sequence requirements.

4.1 DA9061 and i.MX 7S Power Rails

The supply rails for an i.MX 7Solo system powered by DA9061 are summarized in Table 1.

<table>
<thead>
<tr>
<th>i.MX 7S Rail or System Rail</th>
<th>DA9061 Regulator</th>
<th>Voltage (V)</th>
<th>Sequence Slot</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>VDD_SNVS_IN</td>
<td>LDO2</td>
<td>3.00</td>
<td>1</td>
<td>Switchable via GPIO3 between 3.0 V and 3.3 V. (GPIO3 = 0 selects 3.3 V)</td>
</tr>
<tr>
<td>VDD_ARM_IN</td>
<td>Buck1</td>
<td>1.15</td>
<td>2</td>
<td>Processor efficiency and lifetime can be optimized by reducing the voltage by I2C register writes after system start-up.</td>
</tr>
<tr>
<td>VDD_SOC_IN</td>
<td>Buck3</td>
<td>1.50 / 1.35</td>
<td>3</td>
<td>Switchable via GPIO2 to support DDR3 and DDR3L. (GPIO2 = 0 selects 1.35 V)</td>
</tr>
<tr>
<td>NVCC_DDR (VDDQ_DDR)</td>
<td>Buck2</td>
<td>3.3</td>
<td>4</td>
<td></td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO1</td>
<td>2.5</td>
<td>5</td>
<td></td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO3</td>
<td>1.8</td>
<td>6</td>
<td></td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO4</td>
<td>1.2</td>
<td>7</td>
<td></td>
</tr>
</tbody>
</table>

This mapping is illustrated in the interconnect block diagram of Figure 1.

VDD_SNVS_IN is supplied by LDO2 and must be powered up first in the sequence.
The voltage for VDD_SOC and VDD_ARM has been set in OTP as 1.15 V. For PCB layouts that have significant ohmic drops along these supply rails, the losses can be compensated for by slightly increasing the level. This is achieved by an I²C software write to DA9061 control VBUCK1_A immediately after system power-up. Additionally, processor efficiency and lifetime can be optimized by reducing the voltage, for example to the recommended typical of 1.00 V, by I²C register writes after system start-up.

**Figure 1: DA9061 Connections to i.MX 7Solo**

- **Note 1**: LDO2 is switchable between 3.0 V and 3.3 V based on GPIO3 level. GPIO3 low gives 3.3 V.
- **Note 2**: DA9061-71 has the autoboot function enabled in OTP. The DA9061-72 has autoboot disabled and is therefore suited for systems requiring an ONKEY wake-up.
- **Note 3**: Pull-up resistors for open-drain lines are not shown.
- **Note 4**: Can connect to an i.MX 7S pin assigned as a GPIO. See [4] Section 8.3.4.
- **Note 5**: Buck2 is switchable between 1.5 V and 1.35 V based on GPIO2 level. GPIO2 low gives 1.35 V.
### 4.2 DA9062 and i.MX 7S Power Rails

The supply rails for an i.MX 7Solo system powered by DA9062 are summarized in Table 2.

#### Table 2: i.MX 7S to DA9062 Power Rail Mapping

<table>
<thead>
<tr>
<th>i.MX 7S Rail or System Rail</th>
<th>DA9062 Regulator</th>
<th>Voltage (V)</th>
<th>Sequence Slot</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>VDD_SNVS_IN</td>
<td>VBBAT</td>
<td>3.00</td>
<td>0</td>
<td>The VBBAT coin-cell charger is enabled in OTP and is powered before other sequenced supplies.</td>
</tr>
<tr>
<td>VDD_ARM_IN</td>
<td>Buck1</td>
<td>1.15</td>
<td>1</td>
<td>Processor efficiency and lifetime can be optimized by reducing the voltage by I²C register writes after system start-up.</td>
</tr>
<tr>
<td>VDD_SOC_IN</td>
<td>Buck2</td>
<td>1.50 / 1.35</td>
<td>2</td>
<td>Switchable via GPIO2 to support DDR3 and DDR3L. (GPIO2 = 0 selects 1.35 V)</td>
</tr>
<tr>
<td>NVCC_DRAM (VDDQ_DDR)</td>
<td>Buck3</td>
<td>3.3</td>
<td>3</td>
<td></td>
</tr>
<tr>
<td>NVCC&lt;x&gt;</td>
<td>Buck4</td>
<td>1.8</td>
<td>4</td>
<td></td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO1</td>
<td>2.5</td>
<td>5</td>
<td></td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO2</td>
<td>3.0 / 3.3</td>
<td>6</td>
<td>Switchable via GPIO3 between 3.0 V and 3.3 V. (GPIO3 = 0 selects 3.3 V)</td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO3</td>
<td>1.8</td>
<td>7</td>
<td></td>
</tr>
<tr>
<td>Peripherals</td>
<td>LDO4</td>
<td>1.2</td>
<td>8</td>
<td></td>
</tr>
</tbody>
</table>

This mapping is illustrated in the interconnect block diagram of Figure 2.

VDD_SNVS_IN is supplied by VBBAT and must be powered up first in the sequence. The VBBAT backup charger is on by default, which powers VDD_SNVS_IN before other supplies.

The voltage for VDD_SOC and VDD_ARM has been set in OTP as 1.15 V. For PCB layouts that have significant ohmic drops along these supply rails, the losses can be compensated for by slightly increasing the level. This is achieved by an I²C software write to DA9061 control VBUCK1_A immediately after system power-up. Additionally, processor efficiency and lifetime can be optimized by reducing the voltage, for example to the recommended typical of 1.00 V, by I²C register writes after system start-up.

The i.MX 7Solo ‘Low Power Mode’ can be supported by a custom OTP variant instead of using the standard variants DA9062-71 and DA9062-72. A custom OTP variant can be supported, for example, by using in-circuit programming of the OTP [3]. Buck4 can be reassigned to supply only VDD_SOC, leaving Buck 1 to supply only VDD_ARM. Then, setting GPIO4_PIN = 0 configures GPIO4 as a SYS_EN port driven by the processor’s PMIC_STBY_REQ signal. With a modified DA9062 supply sequence, the system can then power off VDD_ARM when PMIC_STBY_REQ becomes active. See [2] Section 4.1.6.5.
Figure 2: DA9062 Connections to i.MX 7S

Note 1 LDO2 is switchable between 3.0 V and 3.3 V based on GPIO3 level. GPIO3 low gives 3.3 V.

Note 2 DA9062-71 has the autoboot function enabled in OTP. The DA9062-72 has autoboot disabled and is therefore suited for systems requiring an ONKEY wake-up.

Note 3 Pull-up resistors for open-drain lines are not shown.

Note 4 Can connect to an i.MX 7S pin assigned as a GPIO. See [4] Section 8.3.4.

Note 5 Buck2 is switchable between 1.5 V and 1.35 V based on GPIO2 level. GPIO2 low gives 1.35 V.

The OTP standard variants DA9062-71 and DA9062-72 have GPIO0 and GPIO1 configured to sense VTTQ and supply VTTR, respectively. Where the VTTR reference is not required, these can instead be configured as GPIOs by configuring register control BUCK4_VTTR_EN = 0.

The variants DA9062-71 and DA9062-72 are used with the schematic and BOM [8] available from the Dialog Support Site.
4.3 DA9062 and i.MX 7S Power Rails for WaRP7 Demo Board

Table 3 summarizes the supply rails for a WaRP7 Demo Board powered by DA9062. VDD_SNVS_IN must be powered up first in the sequence. It is supplied by the VBBAT backup charger which is on by default. This powers VDD_SNVS_IN before other supplies.

Table 3: i.MX 7S WaRP7 CPU Board to DA9062 Power Rail Mapping

<table>
<thead>
<tr>
<th>i.MX 7S Rail or System Rail</th>
<th>DA9062 Regulator</th>
<th>Voltage (V)</th>
<th>Sequence Slot</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>VDD_SNVS_IN</td>
<td>VBBAT</td>
<td>3.00</td>
<td>0</td>
<td>The VBBAT coin-cell charger is enabled in OTP and is powered before other sequenced supplies.</td>
</tr>
<tr>
<td>VDD_ARM_IN VDD_SOC_IN</td>
<td>Buck1</td>
<td>1.15</td>
<td>1</td>
<td>Processor efficiency and lifetime can be optimized by reducing the voltage by I²C register writes after system start-up.</td>
</tr>
<tr>
<td>NVCC_1V8</td>
<td>Buck4</td>
<td>1.80</td>
<td>2</td>
<td></td>
</tr>
<tr>
<td>NVCC_DRAM</td>
<td>Buck2</td>
<td>1.2</td>
<td>3</td>
<td></td>
</tr>
<tr>
<td>VLDO1_1V8</td>
<td>LDO1</td>
<td>1.8</td>
<td>2</td>
<td></td>
</tr>
<tr>
<td>VLDO2_1V2</td>
<td>LDO2</td>
<td>1.2</td>
<td>N/A</td>
<td></td>
</tr>
<tr>
<td>VLDO3_1V8</td>
<td>LDO3</td>
<td>1.8</td>
<td>2</td>
<td></td>
</tr>
<tr>
<td>VLDO4_1V8</td>
<td>LDO4</td>
<td>1.8</td>
<td>N/A</td>
<td></td>
</tr>
<tr>
<td>NVCC_SD2</td>
<td>Buck3</td>
<td>3.15</td>
<td>2</td>
<td></td>
</tr>
<tr>
<td>NVCC_3V15</td>
<td>Buck3</td>
<td>3.15</td>
<td>2</td>
<td></td>
</tr>
</tbody>
</table>

The above mapping is illustrated in the interconnect block diagram of Figure 3.
Figure 3: DA9062 Connections to WaRP7 Demo Board

Note 1  Pull-up resistors for open-drain lines are not shown.
Note 2  Demo Board on-key is used. DA9062 nONKEY is unused.

The schematic, PCB layout and BOM are available as ‘DA9062_iMX7_design_files.zip’ [8]. These and the OTP ini files are available from the Dialog Support Site.
4.4 Power-up Sequence

The sequence used by the standard variants DA9061-71, DA9061-72, DA9062-71 and DA9062-72 conforms to the requirements described in the i.MX 7Solo datasheet [5] and reference manual [4]. Figure 4 shows the power-up sequence generated by the DA9061-71 and DA9061-72, which meets the i.MX 7S start-up requirements. Figure 5 shows the sequence for DA9062-71 and DA9062-72.

4.5 Power-down Sequence

The power-down sequence is the reverse of power-up. Therefore, the i.MX 7Solo requirement is met for VDD_SNVS_IN to be turned off last after any other power supply. Restrictions for other supplies are discussed in [5].

4.6 I²C Interface

An I²C interface between the i.MX 7S and the DA9061/2 device allows software, including the operating system kernel, to access the internal PMIC registers for control and monitoring. The slave address of the DA9061/2 is 0xB0.

4.7 Recommended External Components

For a list of recommended external components, please refer to the schematic [8], and the DA9061/2 datasheets [6], [7]. The recommended values of inductors and capacitors must be used at the output of all bucks and LDOs to guarantee the closed-loop stability and optimum efficiency of the supplies.
5 Scalable Power Management Solutions

Some systems require more regulators than available from the DA9061. This is frequently due to the demands of the peripherals. In these circumstances, other Dialog PMICs in the same family (for example, DA9062, DA9063, and DA9063L) are likely to provide suitable solutions. The DA9062 is pin-compatible with the DA9061 and provides additional features often required by i.MX 7 systems such as a real-time clock (RTC), DDR memory termination (DA9062 VTT supply), VTTR memory reference voltage, and a dual-phase (5 A) buck configuration. For battery-powered systems, the DA9021 and DA9022 may also be suitable.

6 Software Driver

After the DA9061/2 has started the i.MX 7 system, software can read and write to the PMIC via the I²C bus. This can be used for further PMIC configuration, such as the GPIOs, interrupt servicing, DVC, watchdog keep-alive writes, and so on. Dialog drivers for Linux™ are available in the Linux kernel from https://kernel.org/ [10] or, if interim assistance is required, from a Dialog Sales representative or via the Dialog Discussion Forum.

7 Development Support Tools and PMIC Configuration Files

To assist with hardware and software development, Dialog provides the following:

- DA9061 evaluation kit
- DA9062 evaluation kit

These evaluation kits contain motherboard and daughterboard for hardware evaluation and software development. They include the SmartCanvas™ GUI software.

- SmartCanvas GUI
  This PC-driven software provides easy access to a device under test (DUT). The GUI is used to exercise the DUT using the I²C interface. Control or measurement of analog and digital pins is supported. SmartCanvas supports the Dialog PMIC OTP configuration file format — .ini files.

- OTP configuration .ini files
  These files define the configuration of the DA9061/2 at boot and define the different variants such as the -71 and -72. The following ini files are available from the Dialog Support Site:
  - DA9061-71_iMX7S_autoboot_v2-ED40.ini (autoboot enabled)
  - DA9061-72_iMX7S_non-autoboot_v2-A78C.ini (autoboot disabled)
  - DA9062-71_iMX7S_autoboot_v1-659C.ini (autoboot enabled)
  - DA9062-72_iMX7S_non-autoboot_v1-5B56.ini (autoboot disabled)
  - DA9062-70_WaRP7_CPU_Board_v02-7768.ini (WaRP7 Demo Board, autoboot).

  These ini files are opened using the SmartCanvas GUI.

- Reference design schematic [8] with details of PMIC to processor interconnections
- WaRP7 CPU Board reference design schematic and layout [9]
- Linux software driver, see Section 6
Device Identification and Ordering

DA9061-71 / DA9062-71 have the autoboot feature enabled in OTP. The DA9061-72 / DA9061-72 have autoboot disabled and are therefore suited for systems requiring an ONKEY wake-up.

If the above standard variants prove unsuitable for your target i.MX 7 design, please contact a Dialog sales representative to discuss custom variants (minimum order quantities apply for custom variants) or consider OTP in-circuit programming as described in [3].

Table 4: Product Part Numbers

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Description (Note 1)</th>
</tr>
</thead>
<tbody>
<tr>
<td>DA9061-71AMx</td>
<td>Autoboot</td>
</tr>
<tr>
<td>DA9061-72AMx</td>
<td>Non-autoboot</td>
</tr>
<tr>
<td>DA9062-71AMx</td>
<td>Autoboot</td>
</tr>
<tr>
<td>DA9062-72AMx</td>
<td>Non-autoboot</td>
</tr>
</tbody>
</table>

Note 1 See the DA9061 and DA9062 datasheets [6] and [7] for further information regarding part ordering. All parts are available in tray (x = 1) or Tape and Reel (x = 2).

Revision History

<table>
<thead>
<tr>
<th>Revision</th>
<th>Date</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.0</td>
<td>16-Feb-2018</td>
<td>First release.</td>
</tr>
</tbody>
</table>
| 1.1      | 18-Dec-2018| ● Section 4.1: DA9061 and i.MX 7S Power Rails  
  ○ Added Note 5 to Figure 1.  
  ○ Corrected Figure 1 Buck1 voltage from 1.40 V to 1.15 V.  
  ○ Added polarity descriptions for GPIO-selectable voltage on GPIO2 and GPIO3 in notes of Figure 1.  
  ● Section 4.2: DA9062 and i.MX 7S Power Rails  
  ○ Added polarity descriptions for GPIO-selectable voltage on GPIO2 and GPIO3 in notes of Figure 2.  
  ● Section 7: Development Support Tools and PMIC Configuration Files  
  ○ Corrected OTPs for DA9061. New OTPs created and listed: ‘DA9061-71_iMX7S_autoboot_v2-ED40.ini’, ‘DA9061-72_iMX7S_non-autoboot_v2-A78C.ini’  
  ○ Updated OTP for WaRP7 demo board to ‘DA9062-70_WaRP7_CPU_Board_v02-7768.ini’. |
DA9061/2 and NXP i.MX 7Solo Power Connections

Status Definitions

<table>
<thead>
<tr>
<th>Status</th>
<th>Definition</th>
</tr>
</thead>
<tbody>
<tr>
<td>DRAFT</td>
<td>The content of this document is under review and subject to formal approval, which may result in modifications or additions.</td>
</tr>
<tr>
<td>APPROVED or unmarked</td>
<td>The content of this document has been approved for publication.</td>
</tr>
</tbody>
</table>

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Application Note  Revision 1.1  18-Dec-2018